# New Jersey Semi-Conductor Products, Inc.

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### VN35AK Series

1.2 AMPERES 35-90 VOLTS RDS(ON) = 2.5-4.5 Ω

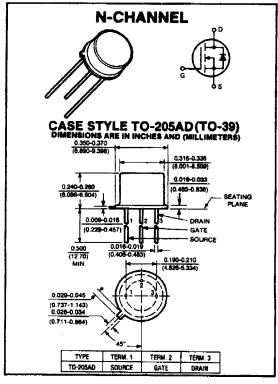
# POWER-MOS FET

#### **Applications**

- · High current analog switches
- RF power amplifiers
- Laser diode pulsers
- Line drivers
- Logic buffers
- Pulse amplifiers

#### **Features**

- High speed, high current switching
- High gain-bandwidth product
- Inherently temperature stable
- Extended safe operating area
- Simple DC biasing
- Requires almost zero current drive



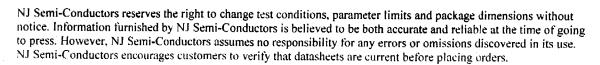
#### maximum ratings (T<sub>A</sub> = 25°C) (unless otherwise specified)

RATING	SYMBOL	VN35AK	VN66AK/67AK	VN98AK/99AK	UNITS
Drain-Source Voltage	VDSS	, 35	60	90	Volts
Drain-Gate Voltage, $R_{GS}$ = 1M $\Omega$	V <sub>DGR</sub>	35	60	90	Volts
Continuous Drain Current @ T <sub>A</sub> = 25°C	ID	1.2	1.2	1.2	Α
Peak Drain Current <sup>(1)</sup>	DM	3.0	3.0	3.0	Α
Gate-Source Voltage	V <sub>GS</sub>	±30	±30	±30	Volts
Total Power Dissipation @ TA = 25°C Derate Above 25°C	PD	6.25 50	6.25 50	6.25 50	Watts mW/°C
Operating and Storage Junction Temperature Range	TJ, TSTG	-55 to 150	-55 to 150	-55 to 150	°C

#### thermal characteristics

Thermal Resistance, Junction to Ambient	RøJA	20	20	20	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/16" from Case for 10 Seconds	ΤĹ	300	300	300	°C

(1) Repetitive Rating: Pulse width limited by max. junction temperature.



**Quality Semi-Conductors** 

# electrical characteristics ( $T_A = 25^{\circ}C$ ) (unless otherwise specified)

CHARACTERISTIC		SYMBOL	MIN	TYP	MAX	UNIT
off characteristics						
Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0V, I <sub>D</sub> = 10 μA)	VN35AK VN66/67AK VN98/99AK	BVDSS	35 60 90	=	=	Volts
Zero Gate Voltage Drain Current (V <sub>DS</sub> = Max Rating, V <sub>GS</sub> = 0V) (V <sub>DS</sub> = Max Rating, × 0.8, V <sub>GS</sub> = 0V, T <sub>A</sub> = 125°C)		IDSS	_	_	10 500	μΑ
Gate-Source Leakage Current (VGS = 15V, VDS = 0V) (VGS = 15V, VDS = 0V - T <sub>A</sub> = 125 °C)		IGSS		_	100 500	nA nA

#### on characteristics\*

Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1 mA)	, , ,	V <sub>GS(TH)</sub>	0.8		2.0	Volts
Drain-Source Saturation Voltage (VGS = 10V, I <sub>D</sub> = 1.0A)	VN66AK VN98AK	V <sub>DS(ON)</sub>	_	_	3.0 4.0	Volts
Drain-Source Saturation Voltage (V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.0A)	VN35AK VN67AK VN99AK	VDS(ON)		=	2.5 3.5 4.5	Volts
On-State Drain Current (V <sub>DS</sub> = 25V, V <sub>GS</sub> = 10V)		ID(ON)	1.0	_	-	Amps
Forward Transconductance (V <sub>DS</sub> = 24V, I <sub>D</sub> = 0.5A)		9fs	.170	_		mhos

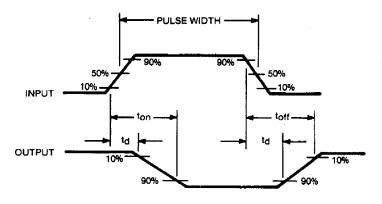
## dynamic characteristics

Input Capacitance	V <sub>GS</sub> = 0V	C <sub>iss</sub>	_	_	50	pF
Output Capacitance	V <sub>DS</sub> = 24V	Coss		_	40	pF
Reverse Transfer Capacitance	f = 1 MHz	Crss	****		10	pF

## switching characteristics\*

Turn-on Delay Time	See switching times	t <sub>d(on)</sub>	_	3	8	ns
Turn-off Delay Time	waveform below	<sup>t</sup> d(off)	_	3	8	ns

<sup>\*</sup>Pulse Test: Pulse width ≤ 300 µs, duty cycle ≤ 2%



**SWITCHING TIME TEST WAVEFORMS**